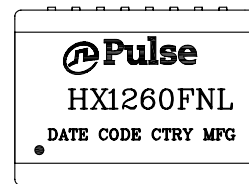


NOTES:

1. ROHS COMPLIANT
2. HEADER: DAP (DIALLYL PHTHALATE) WITH FLAMMABILITY RATING UL 94V-0 OR BETTER.
3. STORAGE TEMPERATURE: -50°C TO +125°C
4. COMPLIANCE TO J-STD:
 - A. J-STD-002: SOLDERABILITY AT 245°C REFLOW PROFILE
 - B. J-STD-020: LEVEL 1, NO MOISTURE SENSITIVE
 - C. J-STD-075: R7, 245°C MAXIMUM THROUGH REFLOW SOLDER
5. TO ORDER TAPE & REEL PACKAGING ADD A "T" SUFFIX TO THE PART NUMBER(i.e HX1260FNL BECOMES HX1260FNLT).

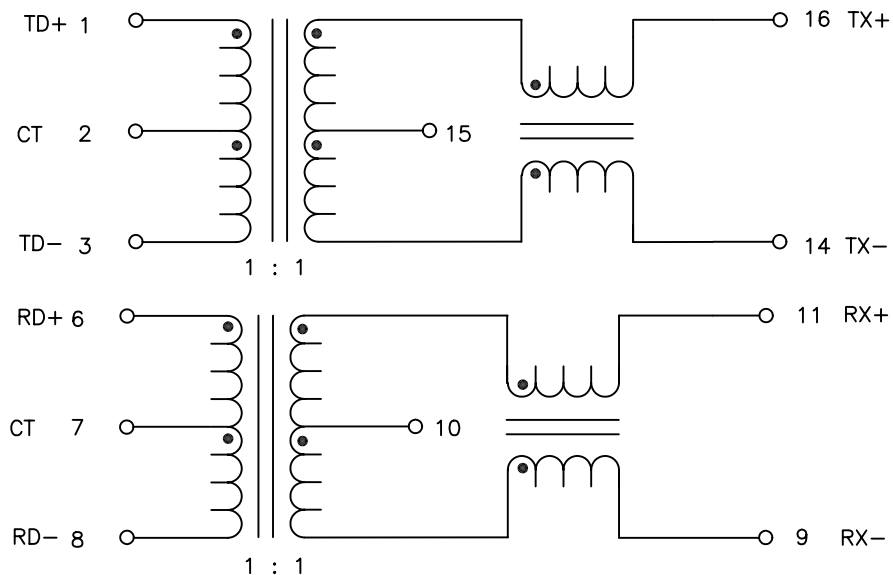


FINAL OUTLINE

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PRODUCT DESCRIPTION	TLA DRAWING	PS DRAWING	SHEET	PART NO.	DATASHEET REV.
MDL,SIN,100D,1:1,SM,OH	HX1260FNL-12	PS-2005.002-D	1 OF 3	HX1260FNL	A

ELECTRICAL CHARACTERISTICS AT +25°C UNLESS OTHER SPECIFIED
MEETS IEEE 802.3 SPECIFICATION



SCHMATIC

PARAMETER	SPECIFICATIONS		
OPERATING TEMPERATURE	-40°C ~ +85°C		
URNS RATIO	1 : 1 ± 2%		
POLARITY	PER SCHEMATIC		
INSERTION LOSS	100 KHz	1-125 MHz	
	-1.2 dB MAX	-0.2-0.002*f ^{1.4} dB MAX	
RETURN LOSS (Z OUT = 100 OHM ±15%)	.1-30 MHz	30-60 MHz	60-80 MHz
	-16 dB MIN	-10+20*LOG ₁₀ (f/60 MHz) dB MIN	-10 dB MIN
INDUCTANCE (OCL) (MEDIA SIDE, -40°C TO +85°C)	350 uH MIN (MEASURED AT 100 KHz, 100 mVRMS)		
CROSSTALK, ADJACENT CHANNELS	1 MHz	10-100 MHz	
	-50 dB MIN	-55+22*LOG ₁₀ (f/10) dB MIN	
COMMON MODE REJECTION RATIO	2 MHz	30-200 MHz	
	-50 dB MIN	-15+20*LOG ₁₀ (f/200) dB MIN	
DC RESISTANCE, 1/2 WINDING	.65 OHMS MAX		
DC RESISTANCE IMBALANCE	±.065 OHMS MAX (CENTER TAP SYMMETRY)		
INPUT - OUTPUT ISOLATION	1500 VRMS MIN @ 60 SECONDS		

NOTE: f IS FREQUENCY IN MHz.

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PRODUCT DESCRIPTION	TLA DRAWING	PS DRAWING	SHEET	PART NO.	DATASHEET REV.
MDL,SIN,100D,1:1,SM,OH	HX1260FNL-12	PS-2005.002-D	2 OF 3	HX1260FNL	A